

SS32-A THRU SS320-A

3.0A Surface Mount Schottky Barrier Rectifiers - 20V-200V

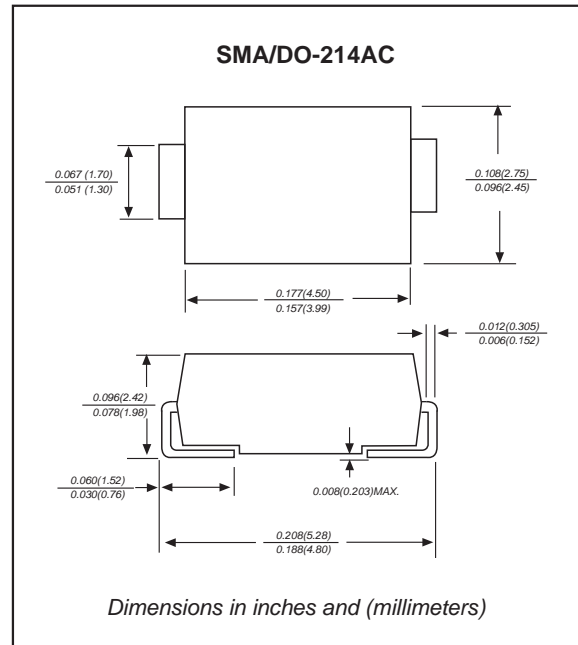
Features

- ▶ The plastic package carries Underwriters Laboratory Flammability Classification 94V-0
- ▶ For surface mounted applications
- ▶ Metal silicon junction, majority carrier conduction
- ▶ Low power loss, high efficiency
- ▶ Built-in strain relief, ideal for automated placement
- ▶ High forward surge current capability
- ▶ High temperature soldering guaranteed: 250°C/10 seconds at terminals
- ▶ Compliant to RoHS Directive 2011/65/EU
- ▶ Suffix "-H" indicates Halogen-free part, ex. SS34-A-H

Mechanical data

- ▶ **Case:** JEDEC DO-214AC molded plastic body
- ▶ **Terminals:** Solder plated, solderable per MIL-STD-750, Method 2026
- ▶ **Polarity:** Color band denotes cathode end
- ▶ **Mounting Position:** Any
- ▶ **Weight:** 0.002 ounce, 0.07 grams

Package outline



Maximum ratings and Electrical Characteristics (AT T_A=25°C unless otherwise noted)

PARAMETER	CONDITIONS	Symbol	MIN.	TYP.	MAX.	UNIT
Forward rectified current	See Fig.2	I _O			3.0	A
Forward surge current	8.3ms single half sine-wave (JEDEC methode)	I _{FSM}			80	A
Reverse current	V _R = V _{RRM} T _A = 25°C	I _R			0.5	mA
	V _R = V _{RRM} T _A = 100°C				10	
Thermal resistance	Junction to ambient NOTE 1	R _{θJA}		55		°C/W
Diode junction capacitance	f=1MHz and applied 4V DC reverse voltage	C _J		500		pF
Storage temperature		T _{STG}	-65		+150	°C

Note: 1.P.C.B. mounted with 0.2x0.2" (5.0x5.0mm) copper pad areas

SYMBOLS	V _{RRM} ^{*1} (V)	V _{RMS} ^{*2} (V)	V _R ^{*3} (V)	V _F ^{*4} (V)	Operating temperature T _J (°C)
SS32-A	20	14	20	0.55	-55 to +125
SS34-A	40	28	40		
SS345-A	45	32	45		
SS35-A	50	35	50	0.70	-55 to +150
SS36-A	60	42	60		
SS38-A	80	56	80	0.85	
SS310-A	100	70	100		
SS315-A	150	105	150	0.92	
SS320-A	200	140	200		

*1 Repetitive peak reverse voltage

*2 RMS voltage

*3 Continuous reverse voltage

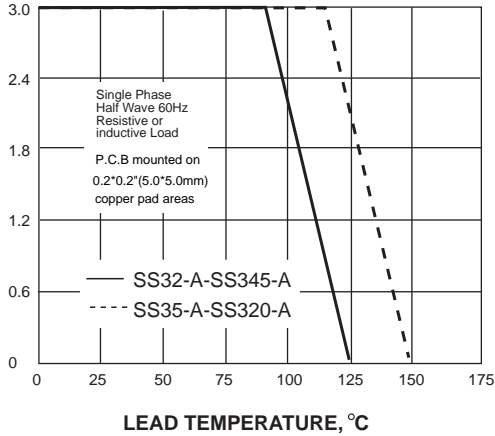
*4 Maximum forward voltage@I_F=3.0A

SS32-A THRU SS320-A

Rating and characteristic curves

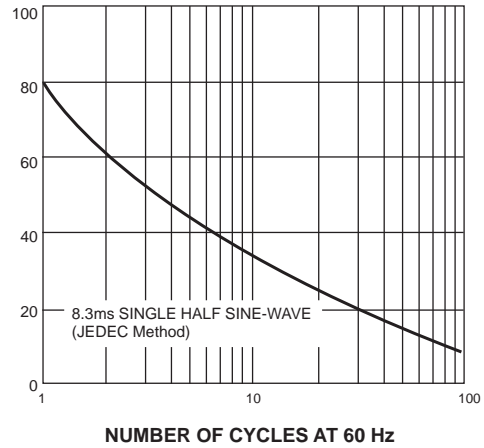
AVERAGE FORWARD RECTIFIED CURRENT, AMPERES

FIG. 1- FORWARD CURRENT DERATING CURVE



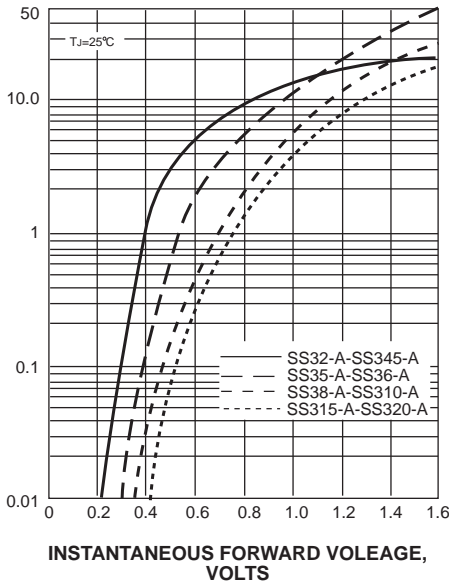
PEAK FORWARD SURGE CURRENT, AMPERES

FIG. 2-MAXIMUM NON-REPETITIVE PEAK FORWARD SURGE CURRENT



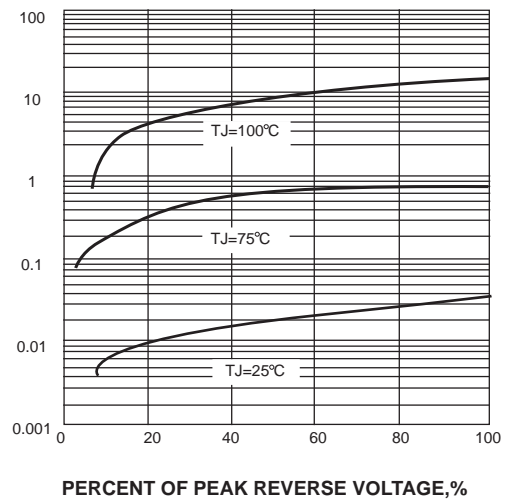
INSTANTANEOUS FORWARD CURRENT, AMPERES

FIG. 3-TYPICAL INSTANTANEOUS FORWARD CHARACTERISTICS



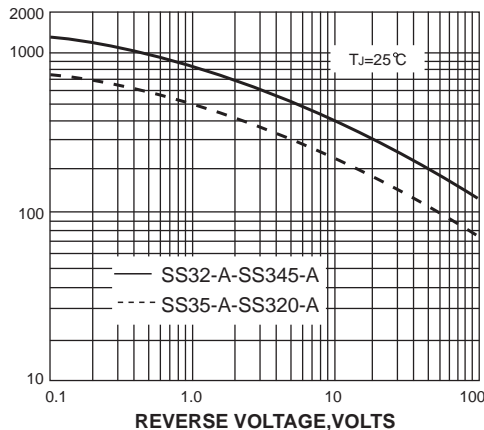
INSTANTANEOUS REVERSE CURRENT, MILLIAMPERES

FIG. 4-TYPICAL REVERSE CHARACTERISTICS



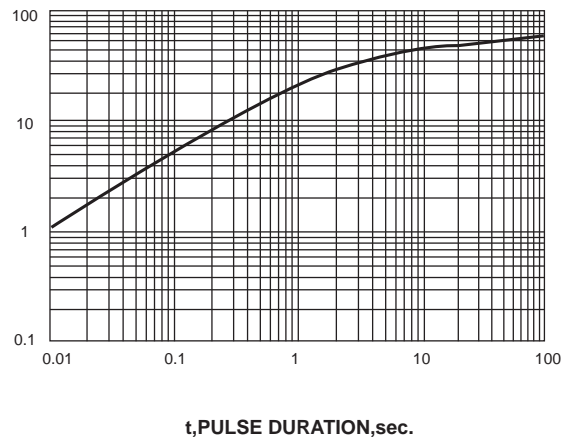
JUNCTION CAPACITANCE, pF

FIG. 5-TYPICAL JUNCTION CAPACITANCE





TRANSIENT THERMAL IMPEDANCE, °C/W

FIG. 6-TYPICAL TRANSIENT THERMAL IMPEDANCE

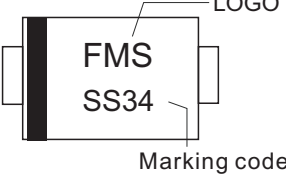
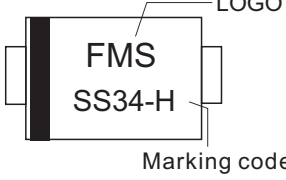


SS32-A THRU SS320-A

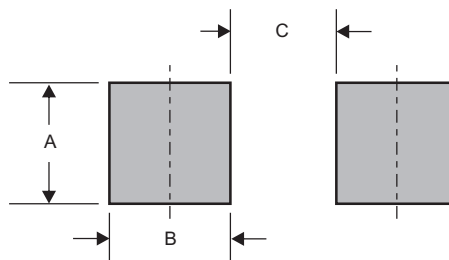
Pinning information

Pin	Simplified outline	Symbol
Pin1 cathode Pin2 anode		

Marking

Type number	Marking code	Example	
SS32-A	SS32	For Halogen Device	For Halogen-free Device
SS34-A	SS34		
SS345-A	SS345		
SS35-A	SS35		
SS36-A	SS36		
SS38-A	SS38		
SS310-A	SS310		
SS315-A	SS315		
SS320-A	SS320		

Suggested solder pad layout



Dimensions in inches and (millimeters)

PACKAGE	A	B	C
SMA	0.110 (2.80)	0.063 (1.60)	0.087 (2.20)